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### Silicon Carbide Power Schottky Diode

### Features

- Industry's leading low leakage currents
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V<sub>F</sub>
- Extremely fast switching speeds
- Superior figure of merit  $Q_C/I_F$

### Advantages

- Low standby power losses
- Improved circuit efficiency (Lower overall cost)
- · Low switching losses
- · Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

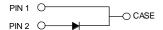
### GB10SLT12-252

V <sub>RRM</sub>	=	1200 V
I <sub>F (Tc = 25°C)</sub>	=	25 A
I <sub>F (Tc ≤ 150°C)</sub>	=	10 A
Q <sub>c</sub>	=	31 nC

### Package







TO – 252

### Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

#### Maximum Ratings at T<sub>j</sub> = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	V <sub>RRM</sub>		1200	V	
Continuous forward current	l <sub>F</sub>	T <sub>C</sub> = 25 °C	25	А	
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> ≤ 150 °C	10	А	
RMS forward current	I <sub>F(RMS)</sub>	T <sub>C</sub> ≤ 150 °C	17	А	
Surge non-repetitive forward current, Half Sine	I <sub>F,SM</sub>	$T_{C} = 25 \text{ °C}, t_{P} = 10 \text{ ms}$	65	А	
Wave		$T_{C} = 150 \text{ °C}, t_{P} = 10 \text{ ms}$	55		
Non-repetitive peak forward current	I <sub>F,max</sub>	$T_{C} = 25 \text{ °C}, t_{P} = 10 \ \mu s$	280	А	
l <sup>2</sup> t value	∫i² dt	$T_{C} = 25 \text{ °C}, t_{P} = 10 \text{ ms}$	21	A <sup>2</sup> s	
		T <sub>C</sub> = 150 °C, t <sub>P</sub> = 10 ms	15	AS	
Power dissipation	P <sub>tot</sub>	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	190	W	
Operating and storage temperature	T <sub>i</sub> , T <sub>stq</sub>		-55 to 175	°C	

### Electrical Characteristics at T<sub>j</sub> = 175 °C, unless otherwise specified

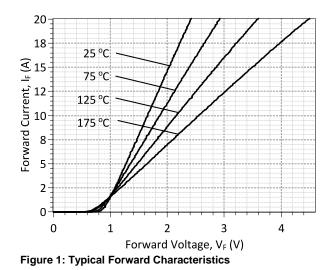
Devementer	Symphol	Conditions –		Values		l lm it	
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	VF	$I_F = 10 \text{ A}, T_j = 2$			1.5	1.8	V
	•		I <sub>F</sub> = 10 A, T <sub>j</sub> = 175 °C		2.6	3.0	
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 1200 V, T <sub>j</sub> = 25 °C		50	250	μA	
	IR	$V_R = 1200 V, T_j =$	: 175 °C		100	500	μΑ
Total capacitive charge	Q <sub>c</sub>	V <sub>R</sub> = 400 V			31		
		$I_F \leq I_{F,MAX}$ V	V <sub>R</sub> = 960 V		52		nC
Switching time	+	dl <sub>F</sub> /dt = 200 A/µs T <sub>i</sub> = 175 °C	$V_{R} = 400 V$		< 25		ns
	ts	V <sub>R</sub> =	V <sub>R</sub> = 960 V				
Total capacitance		V <sub>R</sub> = 1 V, f = 1 MHz, T <sub>j</sub> = 25 °C		490			
	С	V <sub>R</sub> = 400 V, f = 1 MHz, T <sub>j</sub> = 25 °C		45		pF	
		V <sub>R</sub> = 1000 V, f = 1 MHz, T <sub>i</sub> = 25 °C			33		

#### **Thermal Characteristics**

Thermal resistance, junction - case	R <sub>thJC</sub>	0.8	°C/W

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### GB10SLT12-252



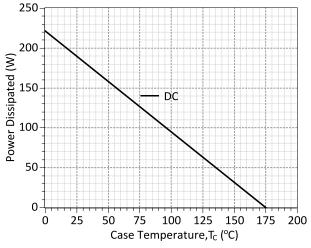
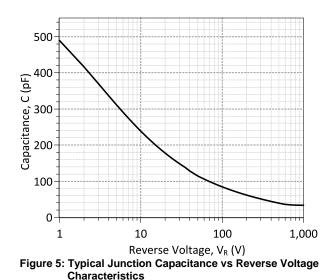


Figure 3: Power Derating Curve



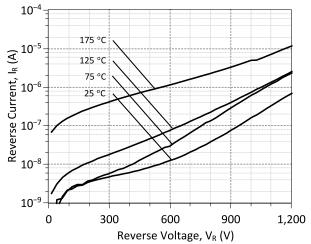
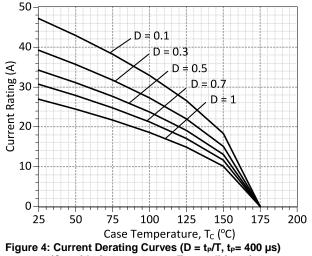
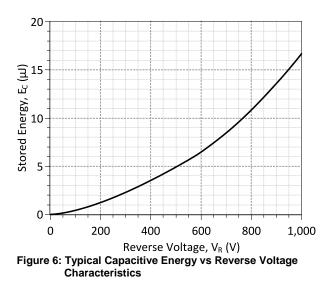


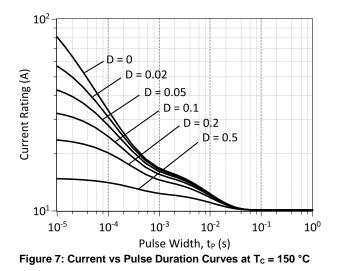
Figure 2: Typical Reverse Characteristics



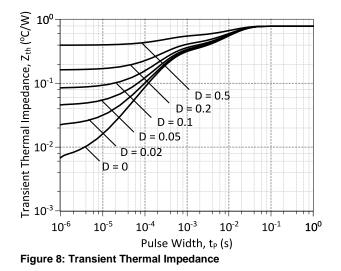
(Considering worst case Z<sub>th</sub> conditions )



### GB10SLT12-252



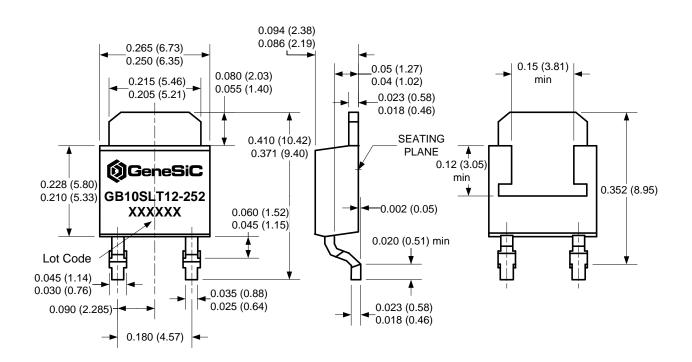
**Genes** 



### Package Dimensions:



#### PACKAGE OUTLINE



#### NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.

2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



### GB10SLT12-252

Revision History					
Date	Revision	Comments	Supersedes		
2014/08/26	4	Updated Electrical Characteristics			
2013/06/12	3	Updated Electrical Characteristics			
2012/12/18	2	Second generation update			
2012/05/22	1	Second generation release			
2010/12/14	0	Initial release			

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### **SPICE Model Parameters**

This is a secure document. Please copy this code from the SPICE model PDF file on our website (http://www.genesicsemi.com/images/products\_sic/rectifiers/GB10SLT12-252\_SPICE.pdf) into LTSPICE (version 4) software for simulation of the GB10SLT12-252.

```
MODEL OF GeneSiC Semiconductor Inc.
*
*
     $Revision: 1.0
                                 $
*
     $Date: 04-SEP-2013
                                 $
*
*
     GeneSiC Semiconductor Inc.
*
     43670 Trade Center Place Ste. 155
     Dulles, VA 20166
*
*
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     COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
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*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
 Models accurate up to 2 times rated drain current.
*
*
 Start of GB10SLT12-252 SPICE Model
.SUBCKT GB10SLT12 ANODE KATHODE
D1 ANODE KATHODE GB10SLT12 SCHOTTKY
D2 ANODE KATHODE GB10SLT12 PIN
.MODEL GB10SLT12 SCHOTTKY D
+ IS
          4.55E-15
                                      0.0736
                           RS
+ N
           1
                                       1000
                           IKF
+ EG
          1.2
                           XTI
                                       -2
+ TRS1
          0.0054347826
                           TRS2
                                       2.71739E-05
+ CJO
          6.40E-10
                           VJ
                                       0.469
+ M
          1.508
                           FC
                                       0.5
+ TT
          1.00E-10
                           ΒV
                                       1200
          1.00E-03
+ IBV
                           VPK
                                       1200
                                       SiC Schottky
+ IAVE
          10
                            TYPE
+ MFG
          GeneSiC Semi
.MODEL GB10SLT12 PIN D
           1.54E-22
                                       0.19
+ IS
                           RS
+ TRS1
          -0.004
                           Ν
                                       3.941
+ EG
          3.23
                           IKF
                                       19
+ XTI
           0
                                       0.5
                           FC
+ TT
           0
                           ΒV
                                       1200
+ IBV
          1.00E-03
                           VPK
                                       1200
+ IAVE
           10
                            TYPE
                                       SiC PiN
.ENDS
* End of GB10SLT12-252 SPICE Model
```

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